

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3036580

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SHUNSUKE ENDO	09/05/2014
RECEIVING PARTY DATA		
Name:	NIPPON CHEMI-CON CORPORATION	
Street Address:	5-6-4, OSAKI	
City:	SHINAGAWA-KU, TOKYO	
State/Country:	JAPAN	
Postal Code:	1418605	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14362123
CORRESPONDENCE DATA		
Fax Number:	(703)610-8686	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	(703)903-9000	
Email:	sdavis@milesstockbridge.com	
Correspondent Name:	MITCHELL W. SHAPIRO	
Address Line 1:	MILES & STOCKBRIDGE P.C.	
Address Line 2:	1751 PINNACLE DRIVE, SUITE 1500	
Address Line 4:	TYSONS CORNER, VIRGINIA 22102	
ATTORNEY DOCKET NUMBER:	XA-12627/T9193-20798US01	
NAME OF SUBMITTER:	SOPHIA L. DAVIS	
SIGNATURE:	/Sophia L. Davis/	
DATE SIGNED:	09/24/2014	
Total Attachments: 1		
source=ASSIGNMENT#page1.tif		

Assignment

WHEREAS, I/We Shunsuke ENDO have made an invention entitled SOLID ELECTROLYTIC CAPACITOR AND METHOD OF MANUFACTURING THE SAME for which I/We have executed an application for Letters Patent of the United States on even date herewith or on _____, or filed an application for Letters Patent of the United States on 30 November 2012 under Application No. PCT/JP2012/081058; and

WHEREAS, NIPPON CHEMI-CON CORPORATION ("ASSIGNEE"), a corporation or other business entity duly organized under the laws of Japan, whose postal address is 5-6-4, Osaki, Shinagawa-ku, Tokyo 1418605, Japan, desires to acquire the entire right, title, and interest in the United States in and to the invention, the application, and any Letters Patent of the United States to be granted for the invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) or the equivalent paid to me/us by ASSIGNEE, and other good and valuable consideration, the receipt and sufficiency of which I/We acknowledge, I/We, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest in the United States in and to the invention, the application, all applications claiming benefit of the application, including, but not limited to, all divisions and continuations of the application, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof; and I/We authorize and request the Director of the United States Patent and Trademark Office to issue all Letters Patent for the invention to ASSIGNEE, its successors, legal representatives, and assigns in accordance with the terms of this Assignment;

AND I/We covenant and agree that I/We have the full right to convey the entire right, title, and interest herein assigned and that I/We have not executed and will not execute any assignment or other instrument in conflict with this Assignment;

AND I/We further covenant and agree that upon request by ASSIGNEE, its successors, legal representatives, and/or assigns, and without further consideration, I/We will do all lawful acts that may be necessary or desirable to assist ASSIGNEE, its successors, legal representatives, and/or assigns to obtain and enforce patent protection for the invention in the United States of America, including, but not limited to, communicate with ASSIGNEE, its successors, legal representatives, and/or assigns any facts known to me/us regarding the invention, testify in any legal proceeding, sign all lawful papers, execute and deliver all papers that may be necessary or desirable to perfect the title to the invention in ASSIGNEE, its successors, legal representatives, and/or assigns, execute all divisional, continuation, and reissue applications, and make all rightful oaths, it being understood that any expense incident to the rendering of such assistance will be borne by ASSIGNEE, its successors, legal representatives, and/or assigns.

IN WITNESS WHEREOF, I/We have executed this Assignment on the date(s) indicated below.

Signature: Shunsuke ENDO

Date: September 5, 2014

Full Name: Shunsuke ENDO

Address: c/o Nippon Chemi-Con Corporation
5-6-4, Osaki, Shinagawa-ku,
Tokyo 1418605, Japan